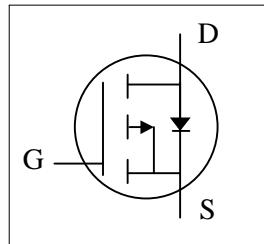




- ▼ Lower On-resistance
- ▼ Simple Drive Requirement
- ▼ Fast Switching Characteristic

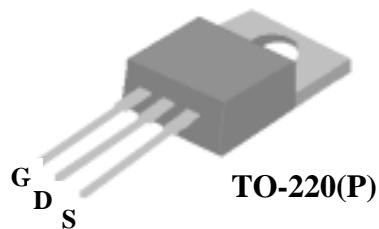
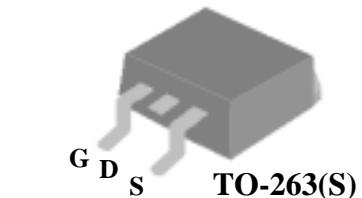


|              |      |
|--------------|------|
| $BV_{DSS}$   | -30V |
| $R_{DS(ON)}$ | 14mΩ |
| $I_D$        | -50A |

## Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-263 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters. The through-hole version (AP4407P) are available for low-profile applications.



## Absolute Maximum Ratings

| Symbol                    | Parameter                                | Rating     | Units |
|---------------------------|--|------------|-------|
| $V_{DS}$                  | Drain-Source Voltage                     | -30        | V     |
| $V_{GS}$                  | Gate-Source Voltage                      | $\pm 25$   | V     |
| $I_D @ T_C = 25^\circ C$  | Continuous Drain Current, $V_{GS} @ 10V$ | -50        | A     |
| $I_D @ T_C = 100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | -32        | A     |
| $I_{DM}$                  | Pulsed Drain Current <sup>1</sup>        | 180        | A     |
| $P_D @ T_A = 25^\circ C$  | Total Power Dissipation                  | 54         | W     |
|                           | Linear Derating Factor                   | 0.4        | W/°C  |
| $T_{STG}$                 | Storage Temperature Range                | -55 to 150 | °C    |
| $T_J$                     | Operating Junction Temperature Range     | -55 to 150 | °C    |

## Thermal Data

| Symbol      | Parameter                           | Value    | Unit |
|-------------|-------------------------------------|----------|------|
| $R_{thj-c}$ | Thermal Resistance Junction-case    | Max. 2.3 | °C/W |
| $R_{thj-a}$ | Thermal Resistance Junction-ambient | Max. 62  | °C/W |



## Electrical Characteristics @ $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol                                     | Parameter  | Test Conditions  | Min. | Typ.  | Max.      | Units                     |
|--|--|--|------|-------|-----------|---------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain-Source Breakdown Voltage                           | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$      | -30  | -     | -         | V                         |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient                | Reference to $25^\circ\text{C}$ , $I_{\text{D}}=-1\text{mA}$ | -    | -0.01 | -         | $\text{V}/^\circ\text{C}$ |
| $R_{\text{DS(ON)}}$                        | Static Drain-Source On-Resistance <sup>2</sup>           | $V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-24\text{A}$        | -    | -     | 14        | $\text{m}\Omega$          |
|  |  | $V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-16\text{A}$       | -    | -     | 23        | $\text{m}\Omega$          |
| $V_{\text{GS(th)}}$                        | Gate Threshold Voltage                                   | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$  | -1   | -     | -3        | V                         |
| $g_{\text{fs}}$                            | Forward Transconductance                                 | $V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-24\text{A}$        | -    | 36    | -         | S                         |
| $I_{\text{DSS}}$                           | Drain-Source Leakage Current ( $T_j=25^\circ\text{C}$ )  | $V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$         | -    | -     | -1        | $\mu\text{A}$             |
|  | Drain-Source Leakage Current ( $T_j=150^\circ\text{C}$ ) | $V_{\text{DS}}=-24\text{V}, V_{\text{GS}}=0\text{V}$         | -    | -     | -25       | $\mu\text{A}$             |
| $I_{\text{GSS}}$                           | Gate-Source Leakage                                      | $V_{\text{GS}}= \pm 25\text{V}$                              | -    | -     | $\pm 100$ | nA                        |
| $Q_g$                                      | Total Gate Charge <sup>2</sup>                           | $I_{\text{D}}=-24\text{A}$                                   | -    | 35    | 60        | nC                        |
| $Q_{\text{gs}}$                            | Gate-Source Charge                                       | $V_{\text{DS}}=-24\text{V}$                                  | -    | 5     | -         | nC                        |
| $Q_{\text{gd}}$                            | Gate-Drain ("Miller") Charge                             | $V_{\text{GS}}=-4.5\text{V}$                                 | -    | 26    | -         | nC                        |
| $t_{\text{d(on)}}$                         | Turn-on Delay Time <sup>2</sup>                          | $V_{\text{DS}}=-15\text{V}$                                  | -    | 11    | -         | ns                        |
| $t_r$                                      | Rise Time  | $I_{\text{D}}=-24\text{A}$                                   | -    | 64    | -         | ns                        |
| $t_{\text{d(off)}}$                        | Turn-off Delay Time                                      | $R_G=3.3\Omega, V_{\text{GS}}=-10\text{V}$                   | -    | 63    | -         | ns                        |
| $t_f$                                      | Fall Time  | $R_D=0.63\Omega$   | -    | 100   | -         | ns                        |
| $C_{\text{iss}}$                           | Input Capacitance  | $V_{\text{GS}}=0\text{V}$                                    | -    | 2120  | 3390      | pF                        |
| $C_{\text{oss}}$                           | Output Capacitance                                       | $V_{\text{DS}}=-25\text{V}$                                  | -    | 630   | -         | pF                        |
| $C_{\text{rss}}$                           | Reverse Transfer Capacitance                             | f=1.0MHz   | -    | 550   | -         | pF                        |

## Source-Drain Diode

| Symbol          | Parameter                          | Test Conditions  | Min. | Typ. | Max. | Units |
|-----------------|------------------------------------|--|------|------|------|-------|
| $V_{\text{SD}}$ | Forward On Voltage <sup>2</sup>    | $I_{\text{S}}=-24\text{A}, V_{\text{GS}}=0\text{V}$                                      | -    | -    | -1.2 | V     |
| $t_{\text{rr}}$ | Reverse Recovery Time <sup>2</sup> | $I_{\text{S}}=-24\text{A}, V_{\text{GS}}=0\text{V},$<br>$dI/dt=-100\text{A}/\mu\text{s}$ | -    | 39   | -    | ns    |
| $Q_{\text{rr}}$ | Reverse Recovery Charge            |  | -    | 38   | -    | nC    |

## Notes:

1. Pulse width limited by safe operating area.
2. Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .

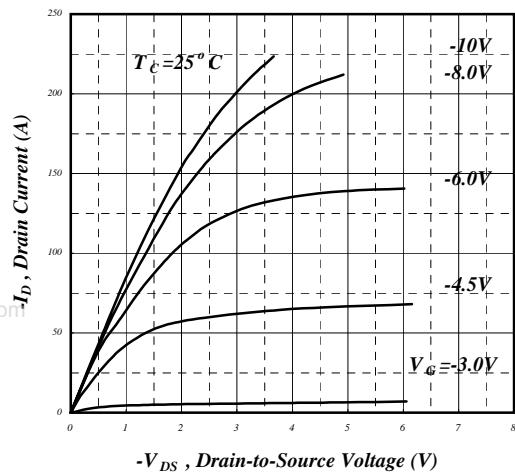


Fig 1. Typical Output Characteristics

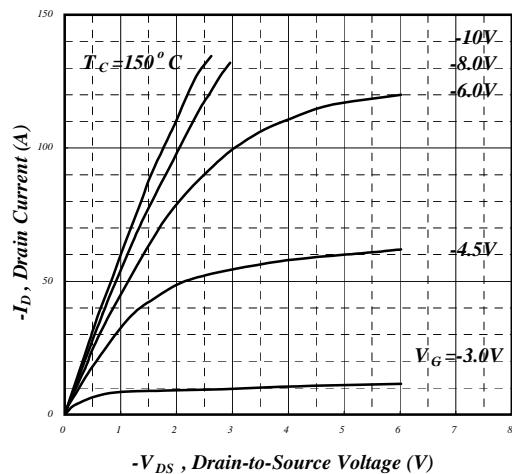


Fig 2. Typical Output Characteristics

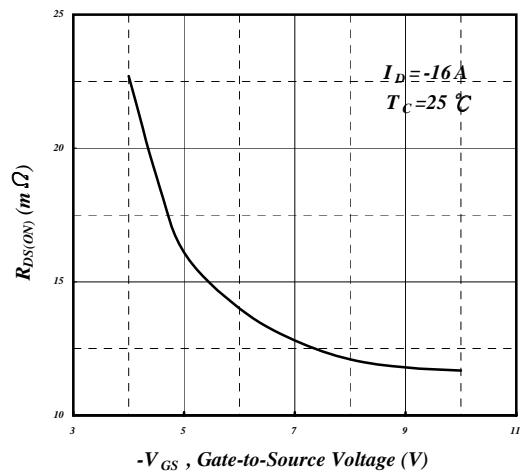


Fig 3. On-Resistance v.s. Gate Voltage

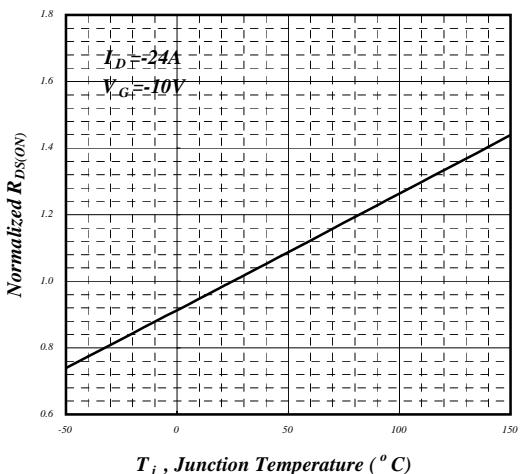


Fig 4. Normalized On-Resistance v.s. Junction Temperature

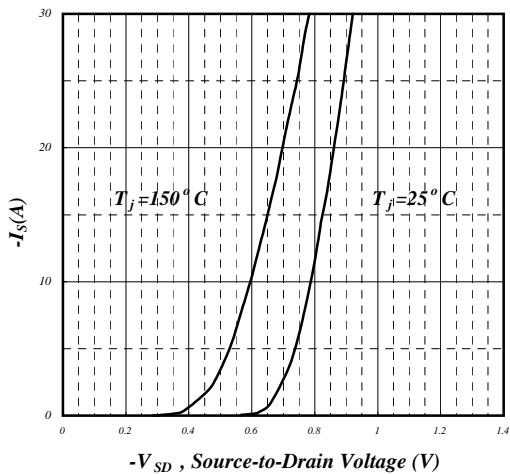


Fig 5. Forward Characteristic of Reverse Diode

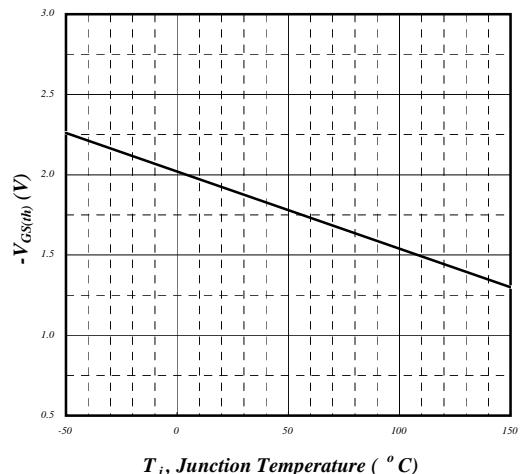


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

